

2.0Amp Surface Mounted Schottky Barrier Rectifiers

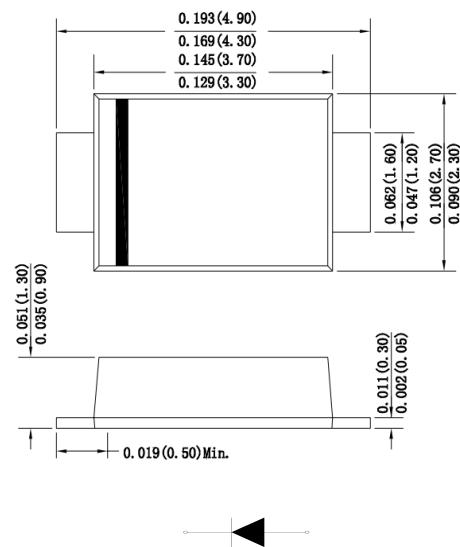
Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Built-in strain relief,ideal for automated placement
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed 250°C/10 seconds at terminals

SMAF

 ROHS
COMPLIANT

 Pb
Free



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	SS22F	SS24F	SS26F	SS28F	SS210F	SS215F	SS220F	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	20	40	60	80	100	150	200	V
Maximum RMS voltage	V _{RMS}	14	28	42	56	70	105	140	V
Maximum DC blocking voltage	V _{DC}	20	40	60	80	100	150	200	V
Maximum average forward rectified current at T _L =100°C	I _(AV)	2.0						A	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	50.0						A	
Maximum instantaneous forward voltage at 2.0A	V _F	0.55		0.70	0.85		0.95	V	
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C	I _R	0.5 50		0.05 10		mA			
Typical thermal resistance	R _{QJA}	70.0						°C/W	
Operating junction temperature range	T _J	-55 to +125			-55 to +150			°C	
Storage temperature range	T _{STG}	-55 to +150						°C	

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

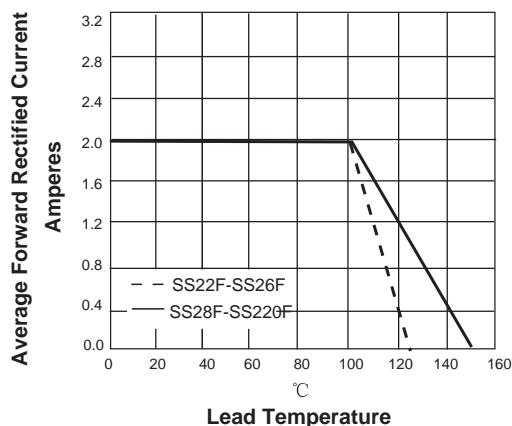


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

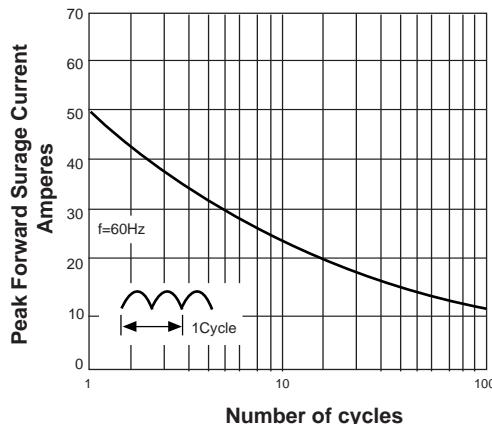


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

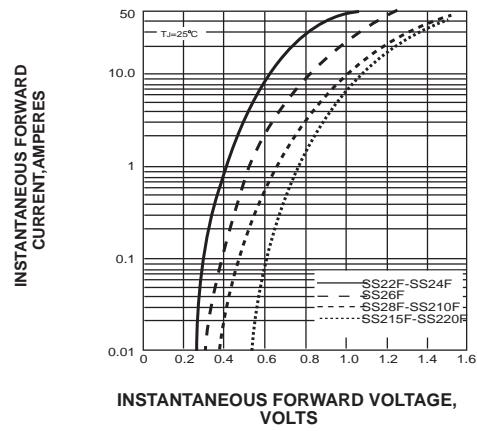
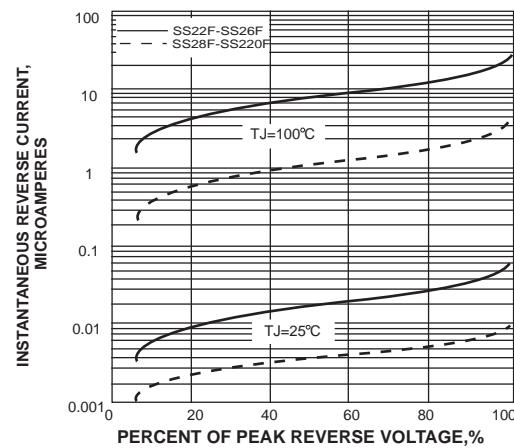
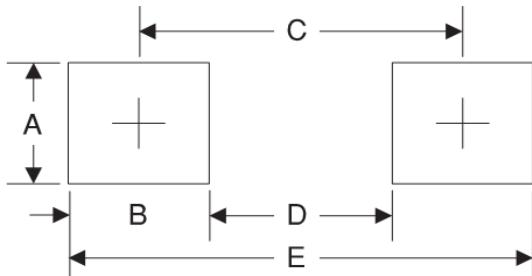


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

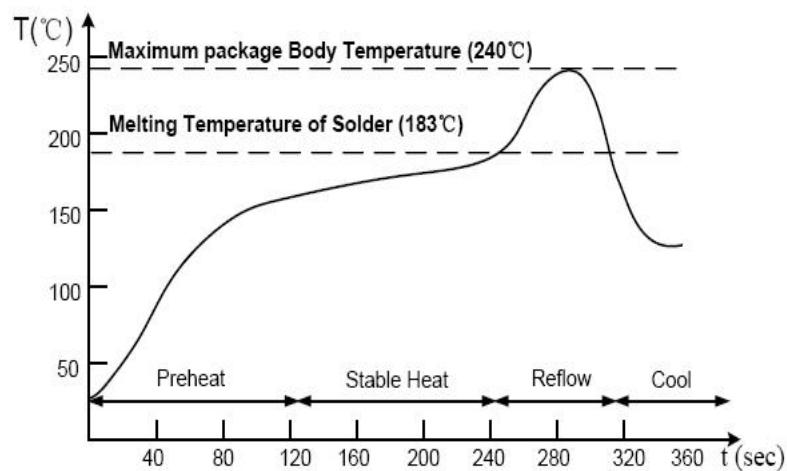


Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
B	1.52	0.060
C	3.90	0.154
D	2.00	0.078
E	5.10	0.200

Suggested Soldering Temperature Profile

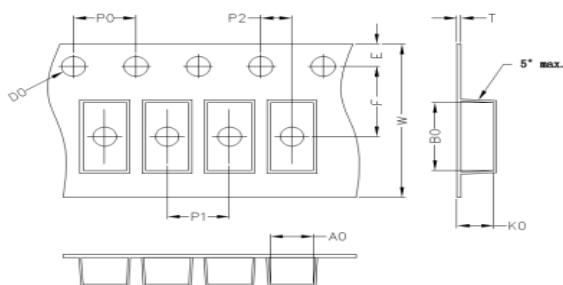


Note

- ◆ Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- ◆ The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- ◆ Devices can be cleaned using standard industry methods and solvents.
- ◆ If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Carrier Dimension(mm)



A0	B0	K0	D0	E	F
2.83	4.75	1.42	1.55	1.75	5.50
P0	P1	P2	T	W	Tolerance
4.0	4.0	2.0	0.25	12	0.1

Package Specifications

Package	Reel Size	Reel DIA. (mm)	Q'TY/Reel (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
SMAF	7'	178	3	180	12	380*200*200	120
	11'	278	7.5	285	15	355*310*310	120

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